

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







DATE	REVISIONS		
4-20-98	E.C.N. #10BRDR. & REDRAWN./	Α	

drawing number LDS—C502RI REV A

ELECTRO-OPTICAL CHARACTERISTICS	T <sub>A</sub> =25°C	$I_f = 10 \text{ mA}$
---------------------------------	----------------------	-----------------------

PARAMETER	MIN	TYP	MAX	ZTINU	TEST COND
PEAK WAVELENGTH FORWARD VOLTAGE REVERSE VOLTAGE AXIAL INTENSITY EMITTED COLOR: FONT COLOR: SEGMENT COLOR:	5.0 GREEN GREY MILKY V	565 (GREEN) 2.2 3900 WHITE DIFFUSED	2.6	nm Vr Vr µcd	I <sub>r</sub> =100µA I <sub>f</sub> =10mA

## LIMITS OF SAFE OPERATION AT 25°C PER CHIP

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT* STEADY CURRENT POWER DISSIPATION DERATE FROM 25°C OPERATING, STORAGE TEMP. SOLDERING TEMP. 2.0mm FROM BODY	150 25 105 -1.2 -40 TO +65 +260	MA MW MW/*C *C *C 3 SEC. MAX

## 2.0mm FROM BODY 3 SEC. MAX \* t<10µS

## RELIABILITY NOTE

DU

OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

LUMEX INCORPORNTED 290 E. HELLEN ROAD PALATINE, ILLINOIS 60067 (B47) 359-2790 Α

CONFIDENTIAL INFORMATION

CONFIDENTIAL INFORMATION

CYCEPT AS SPECIFICALLY AUTHORIZED IN WHITING BY LIMIT INFORPORATED, THE HOLDER OF

THIS DOCUMENT SHALL KEEP ALL INFORMATION CONTINUED HEREIN CONFIDENTIAL AND SHALL PROTECT

SAME IN WHOLE OR IN PART FROM DISCLOSURE AND DISSEMINATION TO ALL THING PARTIES.

DATE: 5-9-97 DWN: CHK'D: APPD:

SCALE: N/A

0.5" SINGLE DIGIT, SEVEN SEGMENT DISPLAY, 565nm GREEN, GREY FONT/WHITE SEGMENTS, COMMON CATHODE.

				DRAWING NUMBER	REV
PAGE	1	OF	1	LDS-C502RI	Α

